N-Channel Enhancement Mode MOSFET

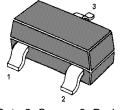
Features

• Surface-mounted package

Gate

Drain

Source



1. Gate 2. Source 3. Drain SOT-23 Plastic Package

Applications

- Portable appliances
- Battery management
- · High speed switch

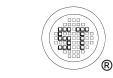
Absolute Maximum Ratings (at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 12	V
Continuous Drain Current	ΙD	3.8	А
Pulsed Drain Current 1)	I _{DM}	15	А
Power Dissipation ²⁾	P _D	1.4	W
Operating Junction Temperature Range	Tj	- 55 to + 150	°C
Storage Temperature Range	T _{stg}	- 55 to + 150	°C

Thermal Resistance Ratings

Parameter	Symbol	Max.	Unit	
Thermal Resistance from Junction to Ambient ²⁾	t ≤ 10 s Steady State	R _θ ЈА	90 125	°C/W

¹⁾ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.



²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

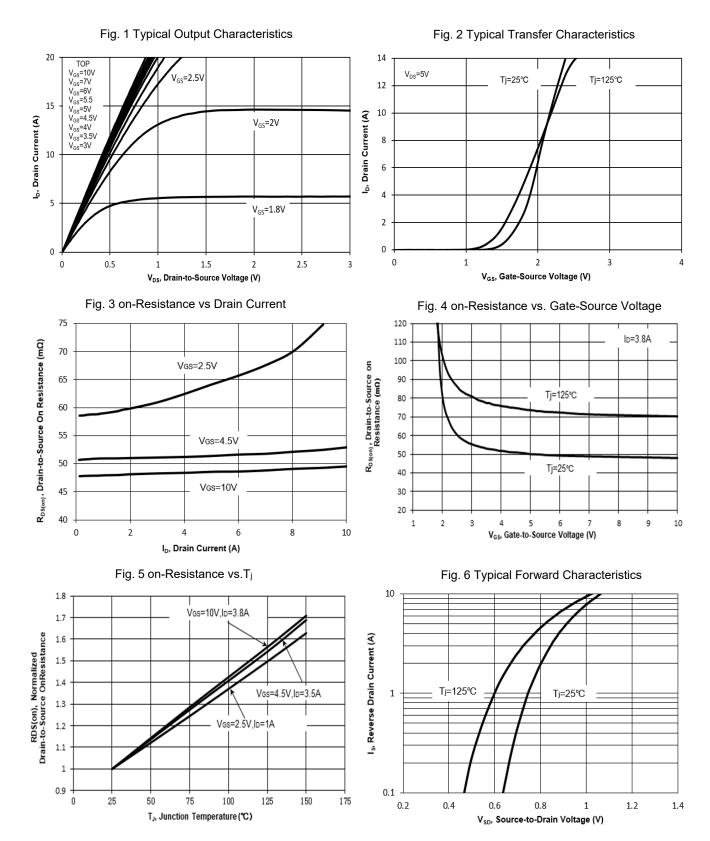
MMFTN3424A

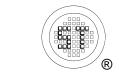
Characteristics at Ta= 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at I _D = 250 µA	V _{(BR)DSS}	30	-	-	V
Zero Gate Voltage Drain Current at V _{DS} = 30 V	I _{DSS}	-	-	1	μΑ
Gate-Source Leakage at $V_{GS} = \pm 12 \text{ V}$	I _{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at V _{DS} = V _{GS} , I _D = 250 μA	$V_{GS(th)}$	0.5	-	1.5	V
Drain-Source On-State Resistance at V_{GS} = 10 V, I_D = 3.8 A at V_{GS} = 4.5 V, I_D = 3.5 A at V_{GS} = 2.5 V, I_D = 1 A	R _{DS(on)}	- - -	- - -	55 65 85	mΩ
DYNAMIC PARAMETERS			ı	1	ı
Forward transfer admittance at V_{DS} = 5 V, I_D = 3.6 A	g FS	-	8	-	S
Gate resistance at $V_{DS} = 0 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	Rg	-	0.6	-	Ω
Input Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	Ciss	-	794	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	Coss	-	52	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	Crss	-	25	-	pF
Gate charge total at V_{DS} = 15 V, I_D = 1.7 A, V_{GS} = 10 V at V_{DS} = 15 V, I_D = 1.7 A, V_{GS} = 4.5 V	Qg	- -	20 9	- -	nC
Gate to Source Charge at V_{DS} = 15 V, I_D = 1.7 A, V_{GS} = 10 V	Q _{gs}	-	2.1	-	nC
Gate to Drain Charge at V_{DS} = 15 V, I_D = 1.7 A, V_{GS} = 10 V	Q_{gd}	ı	2	-	nC
Turn-On Delay Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1.7 A, R_g = 3.3 Ω	$t_{\text{d(on)}}$	-	14	-	ns
Turn-On Rise Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1.7 A, R_g = 3.3 Ω	t _r	-	8	-	ns
Turn-Off Delay Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1.7 A, R_g = 3.3 Ω	$t_{d(off)}$	-	13.6	-	ns
Turn-Off Fall Time at V_{GS} = 10 V, V_{DS} = 15 V, I_D = 1.7 A, R_g = 3.3 Ω	t _f	-	2.1	-	ns
Body-Diode PARAMETERS					
Body Diode Voltage at Is = 1 A	VsD	-	-	1	V
Body-Diode Continuous Current	Is	-	-	3.8	Α
Body Diode Reverse Recovery Time at I _S = 1.7 A, V _{DD} = 15 V, di/dt = 100 A / μs	t _{rr}	-	8	-	ns
Body Diode Reverse Recovery Charge at I _S = 1.7 A, V _{DD} = 15 V, di/dt = 100 A / μs	Qrr	-	4	-	nc



Electrical Characteristics Curves





Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

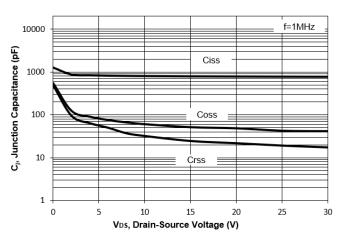


Fig. 8 Drain-Source Leakage Current vs. T_j

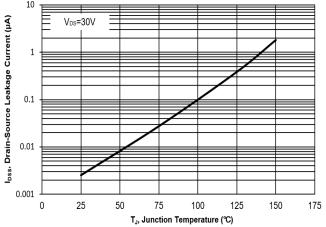


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

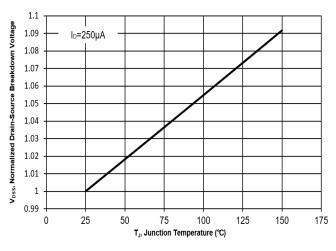


Fig. 10 Gate Threshold Variation vs. T_j

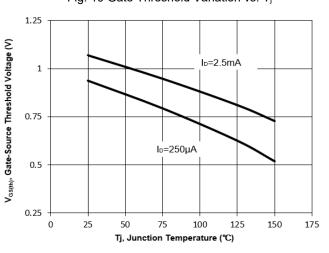
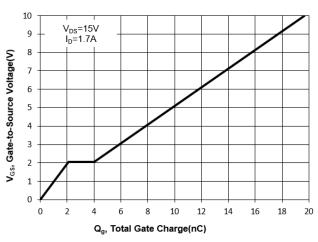
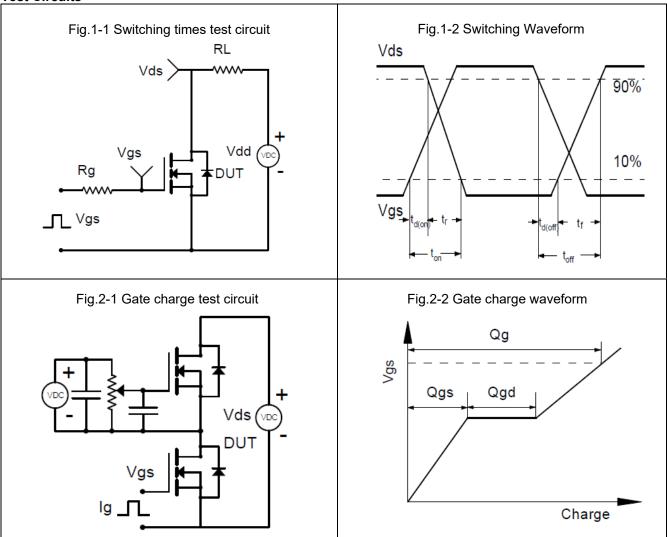


Fig. 11 Gate Charge



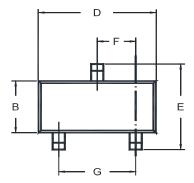


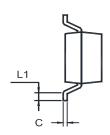
Test Circuits

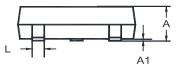


Package Outline (Dimensions in mm)

SOT-23

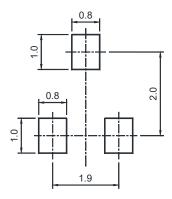






Unit	Α	A1	В	С	D	Е	F	G	L	L1
	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



Packing information

uoiting iiiioi							
Package	Tape Width (mm)	Pitch		Reel	Size		
		mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

Marking information

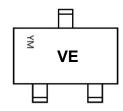
" VE " = Part No.

" YM " = Date Code Marking

" Y " = Year

" M " = Month

Font type: Arial



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